MOSFET – Single, N-Channel, Small Signal, ESD Protection, SC-70/SOT-323 25 V, 0.75 A

Features

- Advance Planar Technology for Fast Switching, Low RDS(on)
- Higher Efficiency Extending Battery Life
- AEC-Q101 Qualified and PPAP Capable NVS4409N
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Boost and Buck Converter
- Load Switch
- Battery Protection

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Rating			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	25	V
Gate-to-Source Voltage			V _{GS}	± 8.0	V
Drain Current	t < 5 s	$t < 5 \text{ s}$ $T_A = 25^{\circ}C$		0.75	А
Continuous Drain Current	Steady State	$T_A = 25^{\circ}C$	I _D	0.7	А
(Note 1)		$T_A = 75^{\circ}C$		0.6	
Power Dissipation (Note 1)	Stead	dy State	PD	0.28	W
Power Dissipation (Note 1)	$t \le 5 s$		PD	0.33	W
Pulsed Drain Current	t _p =	10 μs	I _{DM}	3.0	А
Operating Junction and Storage Temperature			T _J , T _{STG}	–55 to +150	°C
Source Current (Body Diode) (Note 1)			I _S	0.3	А
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C
ESD Rating – Machine Model				25	V

THERMAL RESISTANCE RATINGS

Rating	Symbol	Мах	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	450	°C/W
Junction-to-Ambient – t \leq 5 s (Note 1)	$R_{\theta JA}$	375	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface mounted on FR4 board using 1 in sq pad size

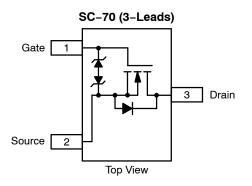
(Cu area = 1.127 in sq [1 oz] including traces).

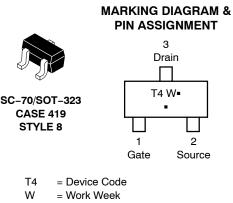


ON Semiconductor®

http://onsemi.com

V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max
25 V	249 mΩ @ 4.5 V	0.75 A
	299 mΩ @ 2.7 V	0.73 A





- = Pb-Free Package
- (Note: Microdot may be in either location)

ORDERING INFORMATION

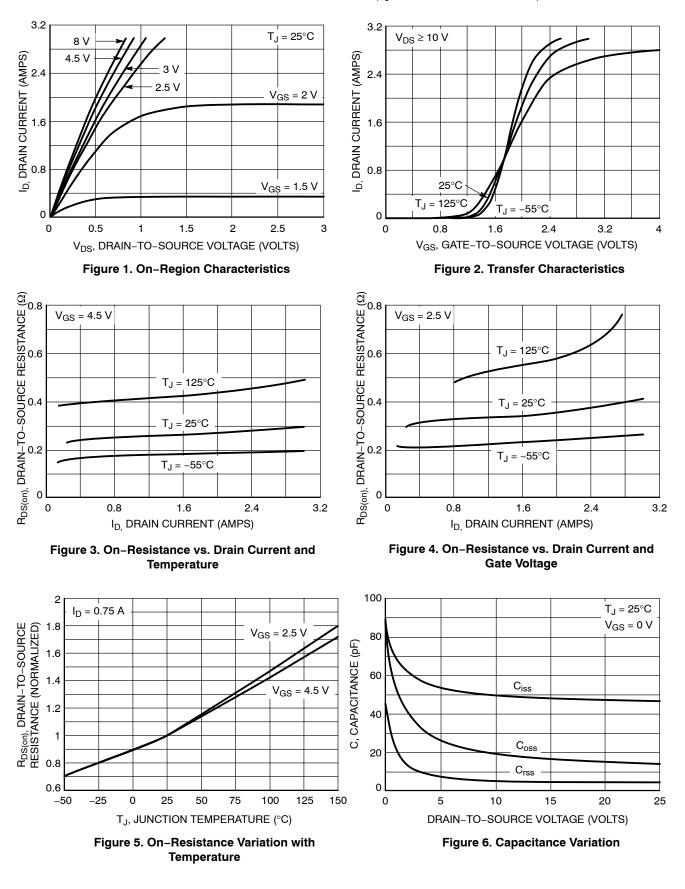
Device	Package	Shipping [†]
NTS4409NT1G	SOT-323 (Pb-Free)	3000 / Tape & Reel
NVS4409NT1G	SOT-323 (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted)

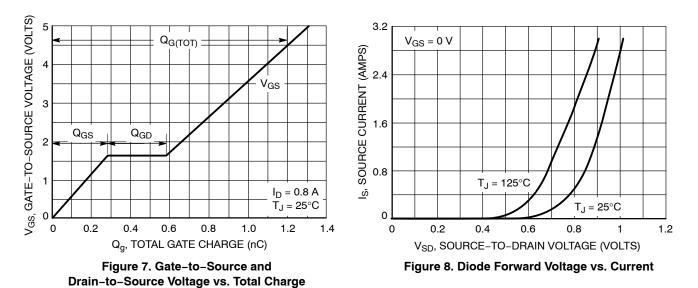
Characteristic	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS						•	•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		25			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				30		mV/∘C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 20 V	$T_J = 25^{\circ}C$			0.5	μΑ
			$T_J = 70^{\circ}C$			2.0	
			T _J = 125°C			5.0	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 8.0 V				100	nA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 250 μA	0.65		1.5	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-2.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	$\begin{array}{c} R_{DS(on)} & V_{GS} = 4.5 \; V, I_{D} = 0.6 \; A \\ \\ \hline V_{GS} = 2.7 \; V, I_{D} = 0.2 \; A \\ \\ \hline V_{GS} = 4.5 \; V, I_{D} = 1.2 \; A \end{array}$			249	350	mΩ
					299	400	
					260		
Forward Transconductance	9 FS	$V_{DS} = 5.0 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$			0.5		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 10 V			49	60	pF
Output Capacitance	C _{OSS}				22.4	30	
Reverse Transfer Capacitance	C _{RSS}	• 03 - 1			8.0	12	1
Total Gate Charge	Q _{G(TOT)}				1.2	1.5	nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V	ns = 15 V,		0.2		
Gate-to-Source Charge	Q _{GS}	$I_{\rm D} = 0.8 \rm{A}$			0.28	0.50	
Gate-to-Drain Charge	Q _{GD}				0.3	0.40	1
SWITCHING CHARACTERISTICS (No	ote 3)					•	•
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 15 V, I _D = 0.7 A, R _G = 51 Ω			5.0	12	ns
Rise Time	t _r				8.2	8.0	
Turn-Off Delay Time	t _{d(OFF)}				23	35	
Fall Time	t _f				41	60	
DRAIN-SOURCE DIODE CHARACTE	RISTICS				-	-	•
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V,$ $I_{S} = 0.6 A$	$T_J = 25^{\circ}C$		0.82	1.20	V

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.



TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

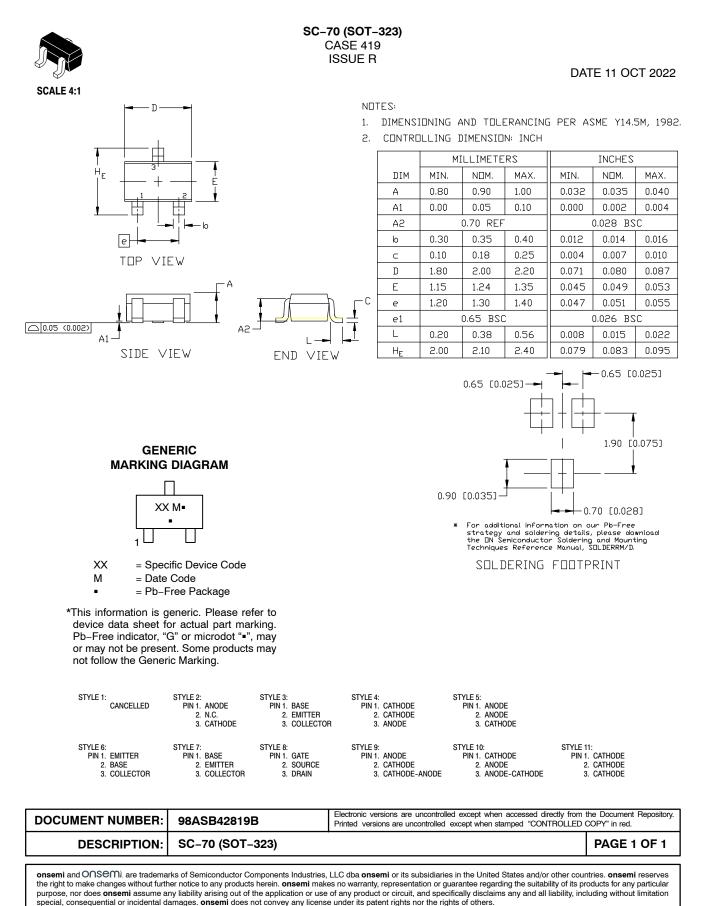
TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)



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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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